

Durez® 33864

Phenolic

Sumitomo Bakelite North America, Inc.

Message:

Durez 33864 is a powdered two-step phenolic resin containing hexamethylenetetramine.

Durez 33864 is used as a raw material in making a liquid slurry adhesive. This adhesive is used to glue together foundry shell molds.

Fast curing resin.

General Information			
Features	Fast Cure		
	Good Adhesion		
Uses	Adhesives		
Forms	Powder		
Thermoset	Nominal Value	Unit	Test Method
Post Cure Time (150°C)	23	hr	
Additional Information	Nominal Value	Unit	Test Method
Hexa	13	%	Internal Method
Inclined Plate Flow (125°C)	3.50	cm	Internal Method
Screen Mesh ¹	< 2.0	%	Internal Method
NOTE			
1.	200 Mesh		

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Recommended distributors for this material

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